

**As a below named inventor, I hereby declare that:**

I believe that I am an original, sole and or joint inventor of the subject matter which is described and for which a patent is sought on the invention entitled

the Specification of which

[illegible]

I hereby state that I have reviewed and understand the contents of the above-identified Specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, 1.56(a).

1 I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any  
2 provisional application filed in the United States in accordance with 35 U.S.C. §1.119(e), or any  
3 application for patent that has been converted to a Provisional Application within one (1) year of its  
4 filing date, or any foreign application(s) for patent or inventor's certificate listed below and have also  
5 identified below any foreign application for patent or inventor's certificate having a filing date before  
6 that of the application on which priority is claimed.

| <u>APPLICATION<br/>NUMBER</u> | <u>COUNTRY</u> | <u>(DAY/MONTH/YEAR FILED)</u> | <u>PRIORITY<br/>CLAIMED</u> |
|-------------------------------|----------------|-------------------------------|-----------------------------|
| 60/235,916                    | US             | 28 September 2000             | YES                         |
| 60/235,917                    | US             | 28 September 2000             | YES                         |
| 60/235,915                    | US             | 28 September 2000             | YES                         |

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application listed below, and, insofar as the subject matter of each of the claims of this application is not disclosed in any prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined

in Title 37, Code of Federal Regulations, §1.56(a), which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

|                 |                                 |  |
|-----------------|---------------------------------|--|
| APPLICATION NO. | FILING DATE<br>(DAY/MONTH/YEAR) | STATUS - PATENTED,<br>PENDING, ABANDONED |
|-----------------|---------------------------------|--|

I hereby appoint as my attorney(s) and agent(s) Heidi M. Brun (Agent, Registration No. 34,504), or Daniel J. Swirsky (Agent, Registration No. 45,148) or Mark S. Cohen (Attorney, Registration No. 42,425) or Rochel L. Abboudi (Agent, Registration No. 44,490) or Suzanne Erez (Agent, Registration No. 46,688) or Vladimir Sherman (Attorney, Registration No. 43,116) or David Klein (Agent, Registration No. 41,118) or Adele Marcus (Agent, Registration No. 47,769) or Caleb Pollack (Attorney, Registration No. 37,912) said attorney(s) and agent(s) with full power of substitution and revocation to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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